

CMOS Digital Integrated Circuits Silicon Monolithic

TC74AC164FT

1. Functional Description

• 8-Bit Shift Register (S-IN, P-OUT)

2. General

The TC74AC164FT is an advanced high speed CMOS 8-BIT SERIAL-IN PARALLEL-OUT SHIFT REGISTER fabricated with silicon gate and double-layer metal wiring C2MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

It consists of a serial-in, parallel-out 8-bit shift register with a CLOCK input and an overriding $\overline{\text{CLEAR}}$ input. Two serial data inputs (A, B) are provided so that one may be used as a data enable.

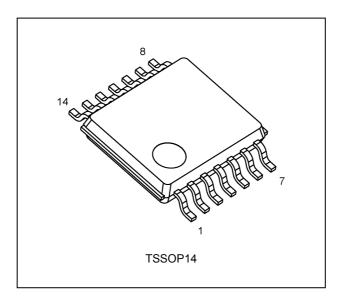
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

3. Features

- (1) Wide operating temperature range: $T_{opr} = -40$ to 125 °C (Note 1)
- (2) High speed: $f_{MAX} = 170 \text{ MHz}$ (typ.) at $V_{CC} = 5.0 \text{ V}$
- (3) Low power dissipation: $I_{CC} = 8.0 \mu A \text{ (max)}$ at $T_a = 25 \text{ °C}$
- (4) High noise immunity: $V_{NIH} = V_{NIL} = 28 \% V_{CC}$ (min)
- (5) Output current: $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 4.5 \text{ V})$
- (6) Balanced propagation delays: t_{PLH} ≈ t_{PHL}
- (7) Wide operating voltage range: $V_{CC(opr)} = 2.0 \text{ V}$ to 5.5 V
- (8) Pin and function compatible with 74F164

Note 1: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after April 2022.

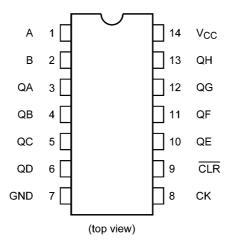
4. Packaging



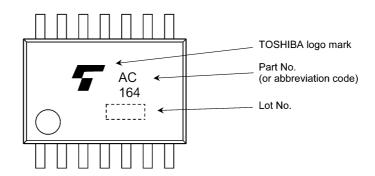
Start of commercial production



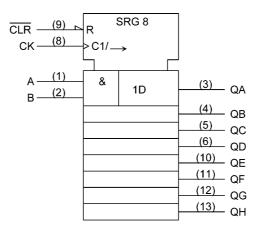
5. Pin Assignment



6. Marking



7. IEC Logic Symbol





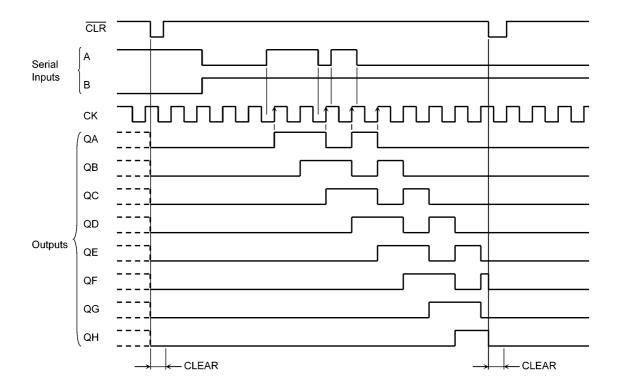
8. Truth Table

	Inputs				Outputs				
CLR	CK Serial IN QA		QA	QB		QH			
CLK	S	A	В	ζ	מ		QH		
L	Х	Х	Х	L	L		L		
Н		Х	Х		No CI	nange			
Н		L	Х	L	QAn		QGn		
Н		Х	L	L	QAn		QGn		
Н	<u></u>	Ι	Τ	Ι	QAn	::	QGn		

X: Don't care

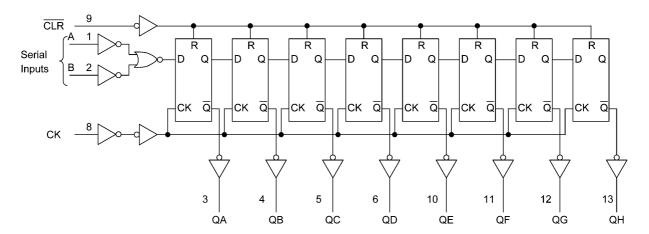
 $\mathsf{QA}_{n} \text{ to } \mathsf{QG}_{n} \text{: } \mathsf{The \ level \ of \ QA \ to \ QG, \ respectively, before \ the \ most \ recent \ positive \ edge \ of \ the \ CK.}$

9. Timing Diagrams





10. System Diagram



11. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 7.0	V
Input voltage	V _{IN}		-0.5 to V _{CC} + 0.5	V
Output voltage	V _{OUT}		-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}		±20	mA
Output diode current	l _{ok}		±50	mA
Output current	l _{out}		±50	mA
V _{CC} /ground current	I _{CC}		±200	mA
Power dissipation	P _D	(Note 1)	180	mW
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 180 mW in the range of T_a = -40 to 85 °C. From T_a = 85 to 125 °C a derating factor of -3.25 mW/°C shall be applied until 50 mW.

12. Operating Ranges (Note)

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Supply voltage	V _{CC}			2.0 to 5.5	V
Input voltage	V _{IN}			0 to V _{CC}	V
Output voltage	V _{OUT}			0 to V _{CC}	V
Operating temperature	T _{opr}	(Note 1)		-40 to 125	°C
Input rise and fall times	dt/dv		V_{CC} = 3.3 \pm 0.3 V	0 to 100	ns/V
			V_{CC} = $5.0 \pm 0.5 \text{ V}$	0 to 20	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Note 1: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after April 2022.



13. Electrical Characteristics

13.1. DC Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	ı	V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	_	V
				3.0	2.10	_	_	
				5.5	3.85	_	_	
Low-level input voltage	V _{IL}	_		2.0	_	_	0.50	V
				3.0			0.90	
				5.5			1.65	
High-level output voltage	V _{OH}	$V_{IN} = V_{IH}$ or V_{IL}	I _{OH} = -50 μA	2.0	1.9	2.0	_	V
				3.0	2.9	3.0	_	
				4.5	4.4	4.5	_	
			I _{OH} = -4 mA	3.0	2.58	_	_	
			I _{OH} = -24 mA	4.5	3.94	_	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0	_	0.0	0.1	V
				3.0	_	0.0	0.1	
				4.5	_	0.0	0.1	
			I _{OL} = 12 mA	3.0	_	_	0.36	
			I _{OL} = 24 mA	4.5			0.36	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		5.5	_		±0.1	μА
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND	_	5.5	_	_	8.0	μА

13.2. DC Characteristics (Unless otherwise specified, Ta = -40 to 85 °C)

Characteristics	Symbol	Test Condition	n	Note	V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_			2.0	1.50	_	V
					3.0	2.10	_	
					5.5	3.85	_	
Low-level input voltage	V _{IL}	_			2.0	_	0.50	V
					3.0	_	0.90	
					5.5	_	1.65	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA		2.0	1.9	_	V
					3.0	2.9	_	
					4.5	4.4	_	
			I _{OH} = -4 mA		3.0	2.48	_	
			I _{OH} = -24 mA		4.5	3.80	_	
			I _{OH} = -75 mA	(Note 1)	5.5	3.85	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA		2.0		0.1	V
					3.0	_	0.1	
					4.5	_	0.1	
			I _{OL} = 12 mA		3.0	_	0.44	
			I _{OL} = 24 mA		4.5	_	0.44	
			I _{OL} = 75 mA	(Note 1)	5.5		1.65	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND			5.5	_	±1.0	μΑ
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND			5.5		40.0	μΑ

Note 1: This spec indicates the capability of driving 50 Ω transmission lines. One output should be tested within a 10 ms maximum duration.



13.3. DC Characteristics (Note) (Unless otherwise specified, T_a = -40 to 125 °C)

Characteristics	Symbol	Test Condition	n	Note	V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_			2.0	1.50	_	V
					3.0	2.10	_	
					5.5	3.85		
Low-level input voltage	V _{IL}	_			2.0	_	0.50	V
					3.0		0.90	
					5.5		1.65	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA		2.0	1.9		V
					3.0	2.9	_	
					4.5	4.4	_	
			I _{OH} = -4 mA		3.0	2.48	_	
			I _{OH} = -24 mA		4.5	3.70	_	
			I _{OH} = -50 mA	(Note 1)	5.5	3.85	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA		2.0		0.1	V
					3.0		0.1	
					4.5		0.1	
			I _{OL} = 12 mA		3.0		0.44	
			I _{OL} = 24 mA		4.5		0.50	
			I _{OL} = 50 mA	(Note 1)	5.5		1.65	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND			5.5		±1.0	μА
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND	_		5.5	_	80.0	μΑ

Note: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after April 2022.

Note 1: This spec indicates the capability of driving 50 Ω transmission lines. One output should be tested within a 10 ms maximum duration.



13.4. Timing Requirements (Unless otherwise specified, T_a = 25 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Limit	Unit
Minimum pulse width (CK)	$t_{w(L)}, t_{w(H)}$	C _L = 50pF	3.3 ± 0.3	_	9.0	ns
		$R_L = 500\Omega$	5.0 ± 0.5	_	5.0	
Minimum pulse width (CLR)	t _{w(L)}	C _L = 50pF	3.3 ± 0.3	_	9.0	ns
		$R_L = 500\Omega$	5.0 ± 0.5	_	5.0	
Minimum setup time	t _s	C _L = 50pF	3.3 ± 0.3	_	7.0	ns
		$R_L = 500\Omega$	5.0 ± 0.5	_	4.0	
Minimum hold time	t _h	C _L = 50pF	3.3 ± 0.3	_	1.0	ns
		$R_L = 500\Omega$	5.0 ± 0.5	_	1.0	
Minimum removal time (CLR)	t _{rem}	C _L = 50pF	3.3 ± 0.3	_	8.5	ns
		$R_L = 500\Omega$	5.0 ± 0.5	_	5.0	

13.5. Timing Requirements (Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Limit	Unit
Minimum pulse width (CK)	$t_{w(L)},t_{w(H)}$	C _L = 50pF	3.3 ± 0.3	_	10.0	ns
		$R_L = 500\Omega$	5.0 ± 0.5	_	6.0	
Minimum pulse width (CLR)	t _{w(L)}	C _L = 50pF	3.3 ± 0.3	_	10.0	ns
		$R_L = 500\Omega$	5.0 ± 0.5	_	6.0	
Minimum setup time	ts	C _L = 50pF	3.3 ± 0.3	_	7.0	ns
		$R_L = 500\Omega$	5.0 ± 0.5	_	4.0	
Minimum hold time	t _h	C _L = 50pF	3.3 ± 0.3	_	1.0	ns
		$R_L = 500\Omega$	5.0 ± 0.5	_	1.0	
Minimum removal time (CLR)	t _{rem}	C _L = 50pF	3.3 ± 0.3	_	8.5	ns
		$R_L = 500\Omega$	5.0 ± 0.5	_	5.0	

13.6. Timing Requirements (Note) (Unless otherwise specified, $T_a = -40$ to 125 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Limit	Unit
Minimum pulse width (CK)	$t_{w(L)}, t_{w(H)}$	C _L = 50pF	3.3 ± 0.3	_	10.0	ns
		$R_L = 500\Omega$	5.0 ± 0.5	_	6.0	
Minimum pulse width (CLR)	t _{w(L)}	C _L = 50pF	3.3 ± 0.3	_	10.0	ns
	$R_L = 500\Omega$		5.0 ± 0.5	_	6.0	
Minimum setup time	Minimum setup time t_s $C_L = 50pF$		3.3 ± 0.3	_	7.0	ns
		$R_L = 500\Omega$	5.0 ± 0.5	_	4.0	
Minimum hold time	t _h	C _L = 50pF	3.3 ± 0.3	_	1.0	ns
		$R_L = 500\Omega$	5.0 ± 0.5	_	1.0	
Minimum removal time ($\overline{\text{CLR}}$) t_{rem} C_{L} = 50pF			3.3 ± 0.3	_	8.5	ns
		$R_L = 500\Omega$	5.0 ± 0.5	_	5.0	

Note: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after April 2022.



13.7. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Тур.	Max	Unit
Propagation delay time (CK-Q)	t _{PLH} ,t _{PHL}		C _L = 50pF	3.3 ± 0.3		9.6	16.3	ns
			$R_L = 500\Omega$	5.0 ± 0.5	_	6.6	9.8	
Propagation delay time (CLR-Q)	t _{PHL}		$C_L = 50pF$	3.3 ± 0.3	_	8.0	15.4	ns
			$R_L = 500\Omega$	5.0 ± 0.5	_	6.0	11.0	
Maximum clock frequency	f _{MAX}		C _L = 50pF	3.3 ± 0.3	45	100	_	MHz
			$R_L = 500\Omega$	5.0 ± 0.5	80	150	_	
Input capacitance	C _{IN}		_		_	5	10	pF
Power dissipation capacitance	C _{PD}	(Note 1)	_		_	110	_	pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

 $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}$

13.8. AC Characteristics

(Unless otherwise specified, T_a = -40 to 85 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
Propagation delay time (CK-Q)	t _{PLH} ,t _{PHL}	C _L = 50pF	3.3 ± 0.3	1.0	18.6	ns
		$R_L = 500\Omega$	5.0 ± 0.5	1.0	11.2	
Propagation delay time (CLR-Q)	t _{PHL}	C _L = 50pF	3.3 ± 0.3	1.0	17.5	ns
		$R_L = 500\Omega$	5.0 ± 0.5	1.0	12.5	
Maximum clock frequency	f _{MAX}	C _L = 50pF	3.3 ± 0.3	45	_	MHz
		$R_L = 500\Omega$	5.0 ± 0.5	80	_	
Input capacitance	C _{IN}	_	•	_	10	pF

13.9. AC Characteristics (Note) (Unless otherwise specified, $T_a = -40$ to 125 °C, Input: $t_r = t_f = 3$ ns)

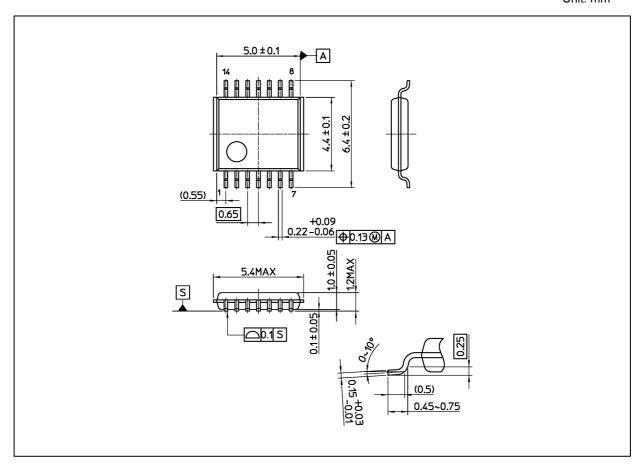
Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
Propagation delay time (CK-Q)	t _{PLH} ,t _{PHL}	C _L = 50pF	3.3 ± 0.3	1.0	20.2	ns
		$R_L = 500\Omega$	5.0 ± 0.5	1.0	12.2	
Propagation delay time (CLR-Q)	t _{PHL}	C _L = 50pF	3.3 ± 0.3	1.0	18.9	ns
		$R_L = 500\Omega$	5.0 ± 0.5	1.0	13.5	
Maximum clock frequency	f _{MAX}	C _L = 50pF	3.3 ± 0.3	45	_	MHz
		$R_L = 500\Omega$	5.0 ± 0.5	80		
Input capacitance	C _{IN}				10	pF

Note: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after April 2022.



Package Dimensions

Unit: mm



Weight: 0.06 g (typ.)

Package Name(s)
Nickname: TSSOP14



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